DESCRIPTION

The SPN1423 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

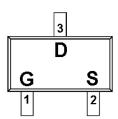
APPLICATIONS

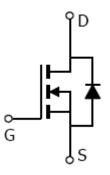
- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

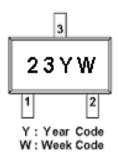
- 20V/2.8A, RDS(ON)= $90m\Omega$ @VGS=4.5V
- 20V/2.2A,RDS(ON)= $100m\Omega$ @VGS=2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOT-323 (SC-70) package design

PIN CONFIGURATION (SOT-323; SC-70)





PART MARKING



PIN DESCRIPTION						
Pin	Symbol	Description				
1	G	Gate				
2	S	Source				
3	D	Drain				

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN1423S32RGB	SOT-323	23

% Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)

 $\begin{tabular}{ll} $\$ SPN1423S32RGB: Tape\ Reel\ ;\ Pb-Free\ ;\ Halogen-Free \end{tabular}$

ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	20	V	
Gate –Source Voltage		VGSS	±12	V	
Continuous Dusin Cumant/Ty-1509C)	Ta=25°C	- ID	2.8	А	
Continuous Drain Current(T _J =150°C)	Ta=70°C		2.2	A	
Pulsed Drain Current		Ірм	10	А	
Continuous Source Current(Diode Conduction)		Is	1.6	А	
Parrier Dissipation	Ta=25°C	PD	1.25	***	
Power Dissipation	Ta=70°C		0.8	W	
Operating Junction Temperature		Tı	150	°C	
Storage Temperature Range		Tstg	-55/150	°C	
Thermal Resistance-Junction to Ambient		RθJA	100	°C/W	

ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit
Static						<u>,I</u>
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V,ID=250uA	20			V
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	0.45		1.2	
Gate Leakage Current	Igss	VDS=0V,VGS=±12V			±100	nA
Zero Gate Voltage Drain Current		VDS=20V,VGS=0V			1	uA
	Idss	VDS=20V,VGS=0V TJ=55°C			10	
On-State Drain Current	ID(on)	$V_{DS} \ge 5V, V_{GS} = 4.5V$	5			A
	ID(0II)	$V_{DS} \ge 5V, V_{GS} = 2.5V$	4			
Drain-Source On-Resistance	RDS(on)	VGS=4.5V,ID=2.8A		0.055	0.090	Ω
		VGS=2.5V,ID=2.2A		0.075	0.100	<u> </u>
Forward Transconductance	gfs	Vds=5V,Id=2.8A		10		S
Diode Forward Voltage	Vsd	Is=1.6A,VGS=0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Qg			5.4	10	nC
Gate-Source Charge	Qgs	V _{DS} =10V,V _{GS} =4.5V I _D =2.8A		0.65		
Gate-Drain Charge	Qgd	10-2.011		1.4		
Input Capacitance	Ciss			340		pF
Output Capacitance	Coss	VDS=10V,VGS=0V -f=1MHz		115		
Reverse Transfer Capacitance	Crss			33		
Turn-On Time	td(on)			12	25	nS
	tr	$V_{DD}=10V,RL=5.5\Omega$		36	60	
Turn-Off Time	td(off)	ID= $2.8A$,VGEN= $4.5V$ RG= 6Ω		34	60	
	tf	v		10	25	

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